

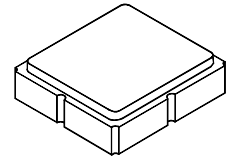


- **Low-loss UHF SAW Filter**
- **3.0 x 3.0 Surface-mount Package**
- **Complies with Directive 2002/95/EC (RoHS)**



SF1219E

2338.75 MHz SAW Filter



SM3030-8

Maximum Rating

Rating	Value	Units
Input Power Level	+15	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Tape and Reel Storage Temperature Range	-40 to +85	°C
Solder Reflow Temperature, 10 seconds/5 cycles maximum	260	°C

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			2338.75		MHz
Maximum Insertion Loss, 2332.5 to 2345 MHz	IL			3.0	3.8	dB
Amplitude Ripple, 2332.5 to 2345 MHz				0.2	1.0	dB _{p-p}
Group Delay Ripple, 2332.5 to 2345 MHz				2.8		ns _{p-p}
Group Delay				12		ns
Input Return Loss, 2332.5 to 2345 MHz			6.5	8.4		dB
Attenuation, 0 dB Reference:						
DC to 2224 MHz			35	41		dB
2453 to 2600 MHz			35	43		
2600 to 3000 MHz			40	44		
3000 to 6000 MHz			25	33		
Single-ended Source Impedance				50		ohm
Balanced Load Impedance				100		

Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization, Y=year, WW=week, S=shift, dot=pin 1 indicator	953, YWWS	
Standard Reel Quantity	Reel Size 7 inch	500 Pieces/Reel
	Reel Size 13 inch	3000 Pieces/Reel

Electrical Connections

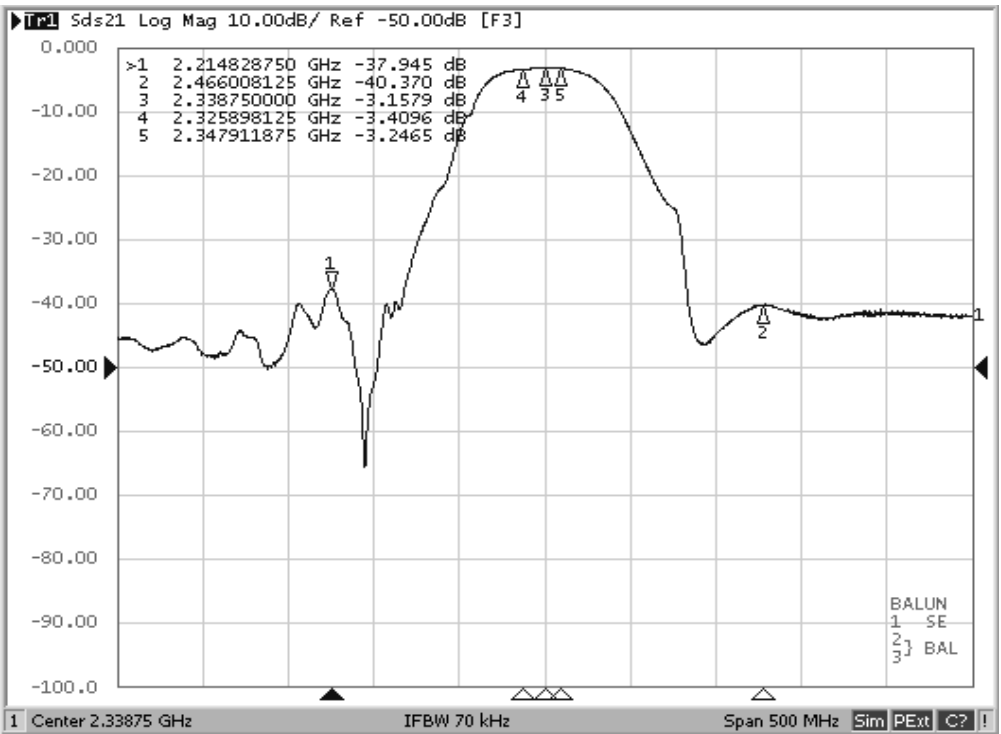
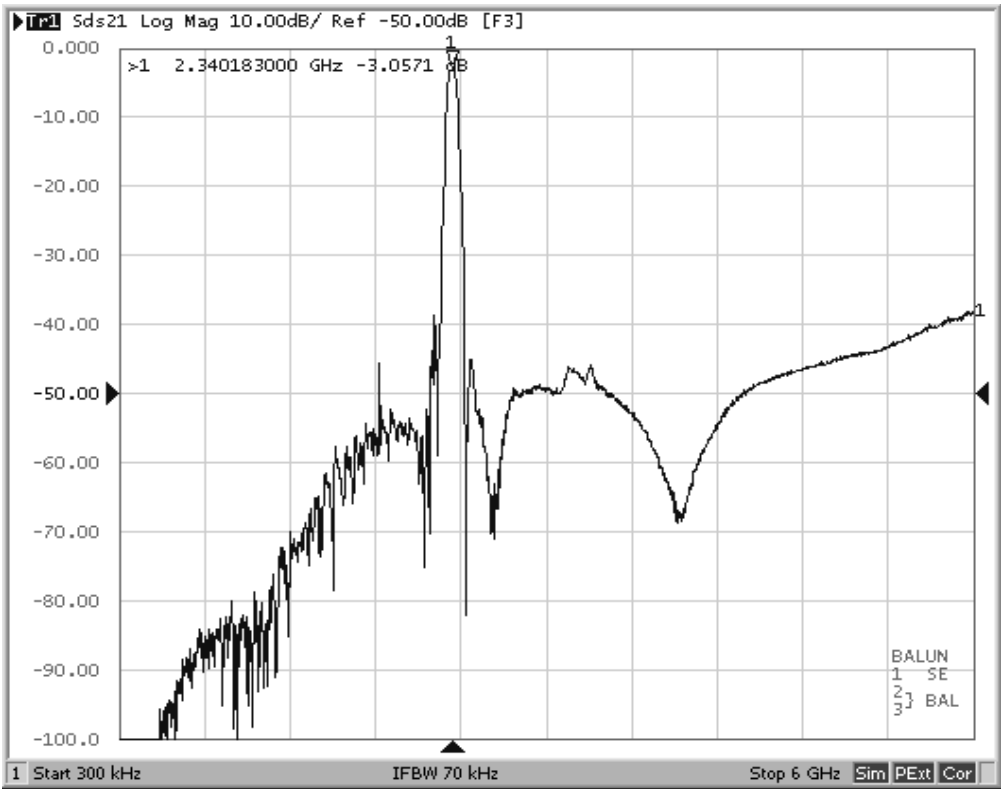
Connection	Terminals
Input	2
Balanced Output	5, 7
Case Ground	All others

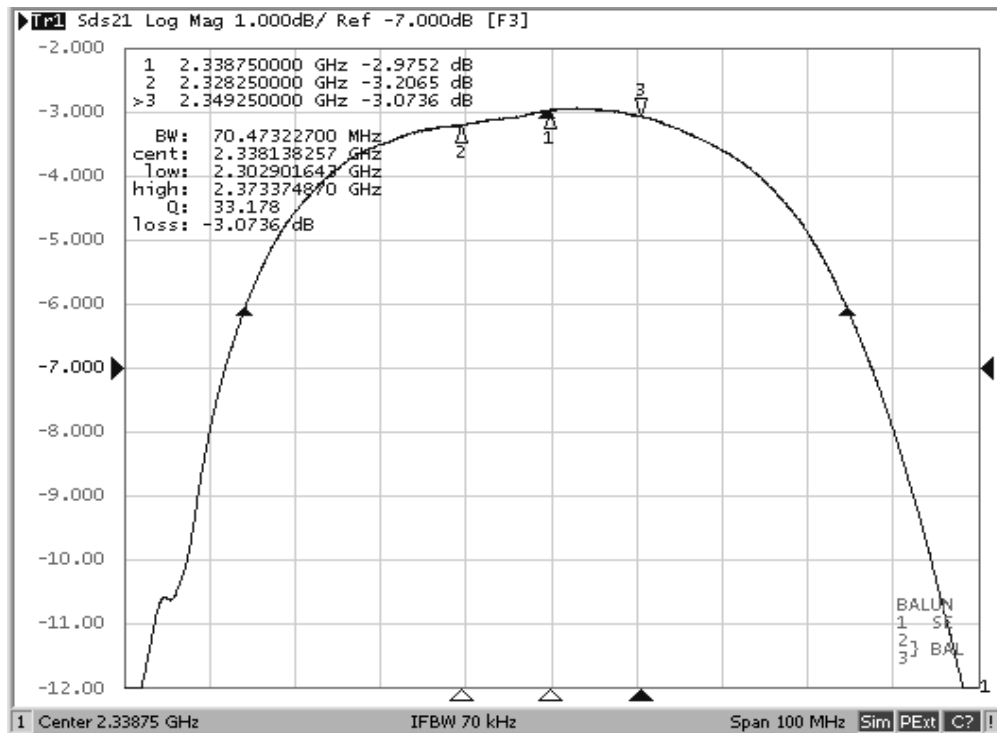
Notes:

1. US and international patents may apply.
2. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
3. Electrostatic Sensitive Device. Observe precautions for handling.

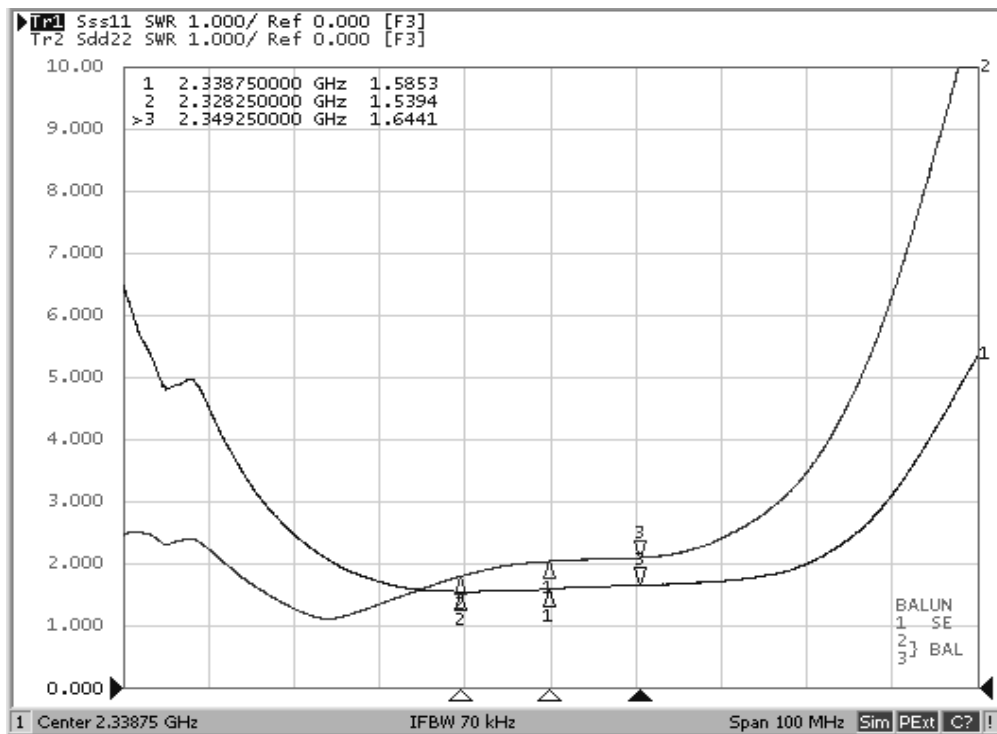


Filter Response Plots

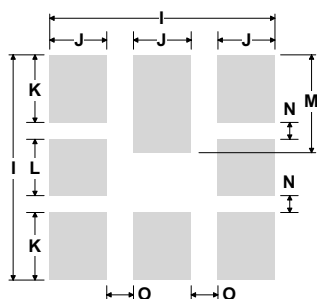
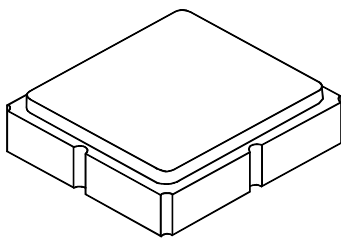




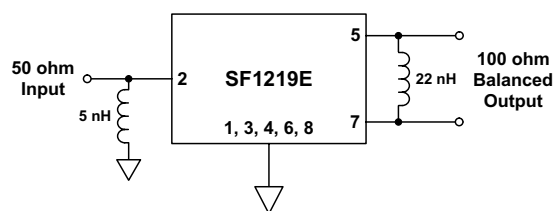
SWR Plots



8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View



Typical Tuning Network

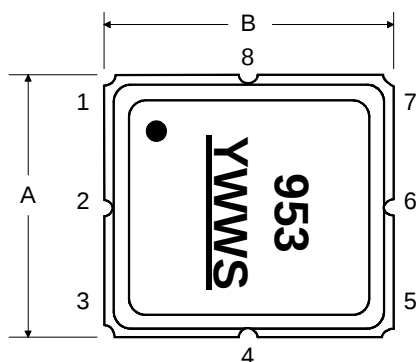
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	-	-	1.10	-	-	0.043
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
O		0.38			0.015	

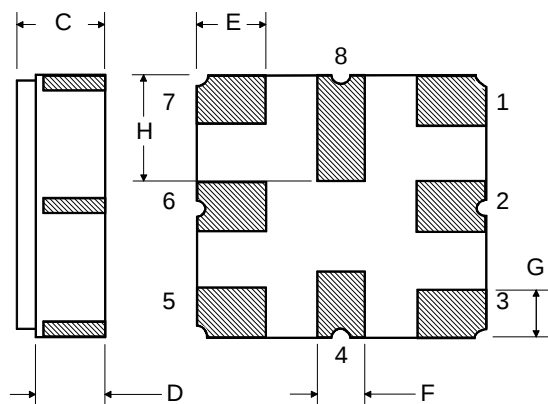
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic
	Pb Free

TOP VIEW



BOTTOM VIEW



Technical drawing of a circular part, likely a flange or end view of a pipe. The drawing includes three views:

- Top View (Main View):** A large circle with a smaller concentric circle in the center. A crosshair (center line) is shown. A dimension line indicates a diameter of 100 REF. (Reference).
- Side View:** A vertical rectangle representing the thickness of the part. A dimension line indicates a thickness of 12.0.
- Detail View (Bottom View):** A cross-section of the central hole, showing a circular hole with a diameter of 20.2. The hole is surrounded by a flange with a thickness of 2.0. The distance from the center of the hole to the outer edge of the flange is 13.0.

Labels and dimensions:

- 100 REF. (Reference diameter)
- 12.0 (Thickness)
- 20.2 (Inner hole diameter)
- 2.0 (Flange thickness)
- 13.0 (Distance from center to outer edge)

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.4 mm
Pitch	8.0 mm
W	12.0 mm

[illegible]